

# RF Driver Amplifier 250 - 3000 MHz

Rev. V2

#### **Features**

- OIP3: 47 dBm
- Broadband Operation
- High Efficiency
- Class 2 ESD Rating
- Lead-Free SOIC-8EP Package
- Halogen-Free "Green" Mold Compound
- RoHS\* Compliant and 260°C Reflow Compatible

#### Description

The MAAM-009563 RF driver amplifier is a two stage GaAs MMIC which exhibits exceptional linearity performance as well as featuring high gain in a lead-free SOIC-8EP surface mount plastic package.

The MAAM-009563 is fabricated using a GaAs HBT process to realize low current and high power functionality. The process features full passivation for increased performance and reliability.

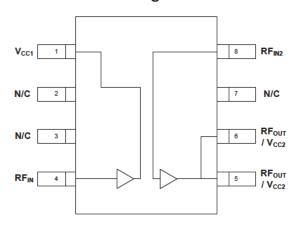
The MAAM-009563 has been designed to be a functional driver amplifier from 250 to 3000 MHz. This broad operation is achieved using external matching components as shown in the PCB layout. Component values are selected to center the 200 MHz instantaneous bandwidth within the overall frequency range.

## Ordering Information<sup>1,2</sup>

Part Number	Package
MAAM-009563-000000	Bulk
MAAM-009563-TR3000	3000 piece reel
MAAM-009563-001SMB	Sample Board

- 1. Reference Application Note M513 for reel size information.
- Sample board includes 5 loose parts.

#### **Functional Block Diagram**



### Pin Configuration<sup>3</sup>

Pin No.	Pin Name	Description	
1	V <sub>CC1</sub>	1st Stage V <sub>CC</sub> & RF Output	
2	N/C	No Connection	
3	N/C	No Connection	
4	RF <sub>IN</sub>	Amplifier Input	
5	RF <sub>OUT</sub> / V <sub>CC2</sub>	Amplifier Output & 2nd Stage V <sub>CC</sub>	
6	RF <sub>OUT</sub> / V <sub>CC2</sub>	Amplifier Output & 2nd Stage V <sub>CC</sub>	
7	N/C	No Connection	
8	RF <sub>IN2</sub>	2nd Stage RF Input	

The exposed pad centered on the package bottom must be connected to the RF and DC ground.

<sup>\*</sup> Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.



RF Driver Amplifier 250 - 3000 MHz

Rev. V2

## Electrical Specifications: Freq. = 2140 MHz, $T_A$ = 25°C, $V_{CC}$ = +5 V, $Z_0$ = 50 $\Omega$

Parameter	Units	Min.	Тур.	Max.
Gain	dB	17	19.5	_
Noise Figure	dB	_	6.25	_
Input Return Loss	dB	_	13	_
Output Return Loss	dB		13	
Output P1dB	dBm	_	31	_
Output IP3 P <sub>N</sub> =-4 dBm / tone, 1 MHz spacing	dBm	44	47	_
Quiescent Current	mA	_	500	_
Current (P <sub>IN</sub> = -1 dBm)	mA	_	510	640

## Absolute Maximum Ratings<sup>4,5</sup>

Parameter	Absolute Maximum
RF Output Power	32 dBm
Voltage	6 volts
Storage Temperature	-65°C to +150°C
Junction Temperature	210°C

Exceeding any one or combination of these limits may cause permanent damage to this device.

### Maximum Operating Conditions<sup>6</sup>

Parameter	Maximum Operating Conditions
Junction Temperature <sup>7</sup>	170°C
RF Output Power	31 dBm
Operating Temperature	-40°C to +85°C

<sup>6.</sup> These operating conditions will ensure MTTF > 1 x 10<sup>6</sup> hours.

 $T_J$  = 74 °C @ 5 V, 535 mA,  $P_{OUT}$  = 24 dBm,  $P_{IN}$  = 4.5 dBm b) For  $T_A$  = 85°C,

 $T_J$  = 123 °C @ 5 V, 430 mA,  $P_{OUT}$  = 24 dBm,  $P_{IN}$  = 5.5 dBm

M/A-COM Technology Solutions does not recommend sustained operation near these survivability limits.

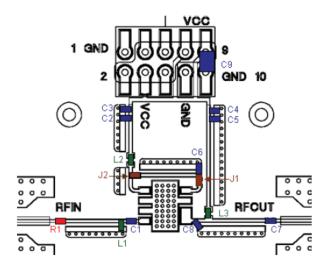
Junction Temperature (T<sub>J</sub>) = T<sub>A</sub> + Θjc \* ((V \* I) - (P<sub>OUT</sub> - P<sub>IN</sub>))
 Typical thermal resistance (Θjc) = 20° C/W
 a) For T<sub>A</sub> = 25°C,



RF Driver Amplifier 250 - 3000 MHz

Rev. V2

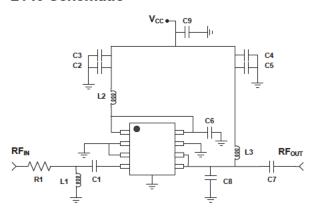
#### 2140 MHz PCB Layout



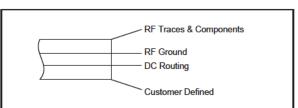
#### **Parts List**

Part	Value	Case Style
C1	1.8 pF	0402
C2, C5	1000 pF	0402
C3, C4	0.1 μF	0402
C6	1.2 pF	0402
C7	39 pF	0402
C8	2.7 pF	0402
C9	3.3 µF	1206
L1	2.4 nH	0402
L2	7.5 nH	0402
L3	8.2 nH	0402
R1	10 Ω	0402
J1, J2	Jumper	

#### 2140 Schematic



#### **Cross Section View**



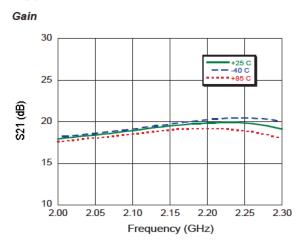
The PCB dielectric between RF traces and RF ground layers should be chosen to reduce RF discontinuities between 50  $\Omega$  lines and package pins. M/A-COM recommends an FR-4 dielectric thickness of 0.008" (0.20 mm) yielding a 50  $\Omega$  line width of 0.015" (0.38 mm). The recommended RF metalization is 1 ounce copper.



**RF Driver Amplifier** 250 - 3000 MHz

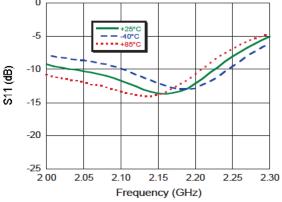
Rev. V2

## Typical Performance Curves: 2140 MHz Configuration

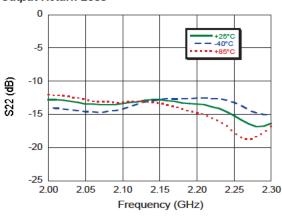


# 0

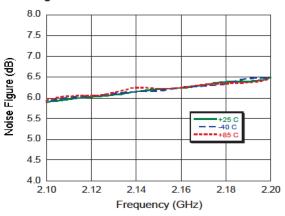
Input Return Loss



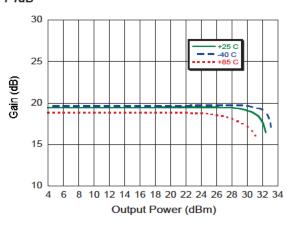
#### **Output Return Loss**



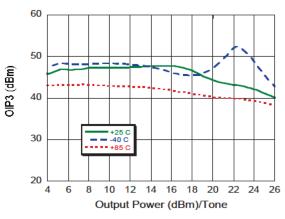
#### Noise Figure



#### P1dB



#### **Output IP3**





RF Driver Amplifier 250 - 3000 MHz

Rev. V2

#### Typical Performance Curves, 2140 MHz Configuration

# 900 800 700 600 400 300 200 4 6 8 10 12 14 16 18 20 22 24 26 28 30 32 34 Output Power (dBm)

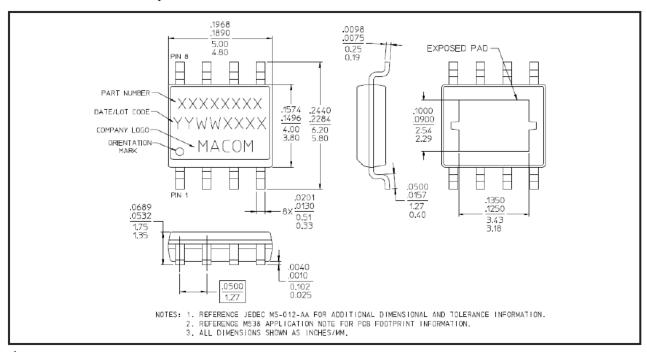
#### **Handling Procedures**

Please observe the following precautions to avoid damage:

#### Static Sensitivity

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these class 2 devices.

#### Lead-Free SOIC-8EP†



Reference Application Note M538 for lead-free solder reflow recommendations. Meets JEDEC moisture sensitivity level 1 requirements. Plating is 100% matte tin over copper.



RF Driver Amplifier 250 - 3000 MHz

Rev. V2

M/A-COM Technology Solutions Inc. All rights reserved.

Information in this document is provided in connection with M/A-COM Technology Solutions Inc ("MACOM") products. These materials are provided by MACOM as a service to its customers and may be used for informational purposes only. Except as provided in MACOM's Terms and Conditions of Sale for such products or in any separate agreement related to this document, MACOM assumes no liability whatsoever. MACOM assumes no responsibility for errors or omissions in these materials. MACOM may make changes to specifications and product descriptions at any time, without notice. MACOM makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions. No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. MACOM FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. MACOM SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.